

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Seung H. Kang, *et al.*

Serial No.: 10/675,258

Filed: September 30, 2003

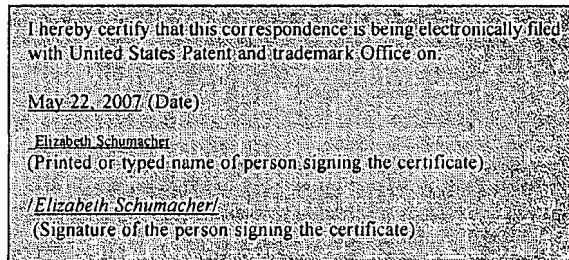
Title: ALUMINUM PAD POWER BUS AND SIGNAL ROUTING FOR
INTEGRATED CIRCUIT DEVICES UTILIZING COPPER
TECHNOLOGY INTERCONNECT STRUCTURES

Grp./A.U.: 2814

Examiner: Thao X. Le

Confirmation No.: 4017

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



Sir:

AMENDMENT UNDER 37 C.F.R. § 1.116

In response to the Examiner's Action mailed March 19, 2007, please reconsider the above-identified application for the following reasons:

Pls
Do
Not
Enter
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